

REMARKS

This communication is in response to Examiner telephonic interviews on April 30, 2010 and May 4, 2010 with Examiner Ngo, the undersigned attorney and Robert L. King (Registration No. 30,185). The pending claims were discussed, but no agreement was reached. Applicants agreed to withdraw the pending application from appeal and file a Request for Continued Examination to provide the Examiner with sufficient time to consider and make of record the previously submitted Information Disclosure Statements filed on January 25, 2005 and April 29, 2010. In addition, Applicants herein submit a new Information Disclosure Statement.

No new matter is introduced as a result of the newly presented claims.

For example, support for the term “rigid” can be found on page 3, lines 1-4, which states, “Substrate 11 can have a variety of forms including...a printed circuit board substrate, and other configurations that are well known to those skilled in the art.” Charles Harper’s *Electronic Packaging and Interconnection Handbook* (cited on the IDS and a copy provided therewith) describes that (organic) printed wiring boards (i.e., printed circuit boards) are either rigid or flexible based on the material being used. A rigid printed circuit board “is fabricated from copper-clad dielectric material. The dielectric consists of an organic resin reinforced with fibers.” (Section 8.2.1.1, first paragraph.) A flexible printed circuit board “is manufactured using ductile copper foil bonded to thin, flexible dielectrics. The dielectric materials includes polyimide (Kapton), polyester terephthalate (Mylar)...” (page 8.6, section 8.2.1.2, second paragraph.)

For example, support for forming a cavity can be found on page 4, lines 18 to 21.

For example, support for providing a dam-bar is provided as element 18 and associated text.

Applicants thank the Examiner for the time and effort spent on the examination of this application. Applicants earnestly request the allowance of pending claims 17 and 20-33.

Respectfully submitted,

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